TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCV17FK

### Hex Schmitt Buffer

The TC74VHCV17FK is an advanced high speed CMOS SCHMITT BUFFER fabricated with silicon gate CMOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

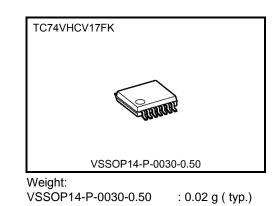
Input pin have hysteresis between the positive-going and negative-going thresholds. Thus the TC74VHCV17FK is capable of squaring up transitions of slowly changing input signals such as line receivers.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output <sup>(Note)</sup> pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, etc.

Note: VCC = 0V.

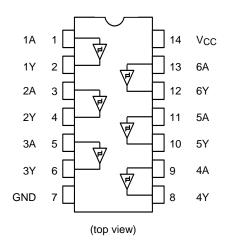
#### Features

- High speed: tpd = 4.5 ns (typ.) at VCC = 5 V
- Low power dissipation: ICC = 2 μA (max) at Ta = 25°C
- Wide operating voltage range: VCC (opr) = 1.8 V to 5.5 V
- Ouput current: |IOH|/IOL = 16 mA (min) (VCC = 4.5 V)
- Available in VSSOP (US)
- Power-down protection provided on all inputs and outputs



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### **Pin Assignment**



### **Truth Table**

А	Y
L	L
Н	Н

### Absolute Maximum Ratings (Note1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	-0.5 to 7.0	V
DC input voltage	Vin	-0.5 to 7.0	V
DC output voltage		-0.5 to 7.0 (Note 2)	V
	Vout	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	v
Input diode current	lıк	-50	mA
Output diode current	IOK	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC V <sub>CC</sub> /ground current	ICC/IGND	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### Note 2: VCC = 0 V

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

### **Operating Ranges (Note1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	1.8 to 5.5	V	
Input voltage	VIN	0 to 5.5	V	
Output voltage	Vout	0 to 5.5 (Note 2)	V	
		0 to V <sub>C</sub> C (Note 3)	V	
Operating temperature	Topr	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 20 (V <sub>CC</sub> = $3.3 \pm 0.3$ V) 0 to 1 (V <sub>CC</sub> = $5 \pm 0.5$ V)	ms/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Note 2: VCC = 0 V

Note 3: High or low state.

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### **Electrical Characteristics**

### **DC Characteristics**

Characteristics Symbol		Test Condition			Ta = 25°C		Ta = −40 to 85°C		Unit	
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	0
Positive threshold voltage	VP	_		1.8 2.3 3.0 4.5 5.5	 		1.65 1.85 2.20 3.15 3.85		1.65 1.85 2.20 3.15 3.85	
Negative threshold voltage	VN	_		1.8 2.3 3.0 4.5 5.5	0.15 0.45 0.90 1.35 1.65			0.15 0.45 0.90 1.35 1.65		V
Hysteresis voltage	νн		_	1.8 2.3 3.0 4.5 5.5	0.15 0.20 0.30 0.40 0.50	     	1.05 1.10 1.20 1.40 1.60	0.15 0.20 0.30 0.40 0.50	1.05 1.10 1.20 1.40 1.60	V
High-level output voltage	V <sub>OH</sub> V <sub>IN</sub> = V	VIN = VIH	I <sub>OH</sub> = -50 μA	1.8 3.0 4.5	1.7 2.9 4.4	1.8 3.0 4.5		1.7 2.9 4.4		
			I <sub>OH</sub> = −8 mA I <sub>OH</sub> = −16 mA	3.0 4.5	2.58 3.94	_	_	2.48 3.80	_	
Low-level output voltage	V <sub>OL</sub> V <sub>IN</sub> = V <sub>I</sub>	VIN = VIL	l <sub>OL</sub> = 50 μA	1.8 3.0 4.5	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1		0.1 0.1 0.1	V
			I <sub>OL</sub> = 8 mA I <sub>OL</sub> = 16 mA	3.0 4.5	_		0.36 0.44		0.44 0.55	
Power-off leakage current	IOFF	VIN/VOUT = 5.5 V		0			0.5		5.0	μA
Input leakage current	l <sub>IN</sub>	$V_{IN} = 5.5 \text{ V or GND}$		0 to 5.5	_		±0.1		±1.0	μA
Quiescent supply current	Icc	VIN = VCC 0	r GND	5.5			2.0		20.0	μA

### AC Characteristics (input: tr = tf = 3 ns)

Characteristics Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit	
		Vcc (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	••••	
. iopugation aoia)		_	2.5 ± 0.2	15	-	9.3	19.7	1.0	22.0	- ns
				50		12.4	24.0	1.0	27.0	
	tpLH tpHL		3.3 ± 0.3	15		6.5	12.8	1.0	15.0	
				50		8.7	16.3	1.0	18.5	
			5.0 ± 0.5	15	_	4.5	8.6	1.0	10.0	
				50		6.1	10.6	1.0	12.0	
Input capacitance	CIN		_			4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note)	_	25	_	_	_	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/6 (per gate)

### Noise Characteristics (input: tr = tf = 3 ns)

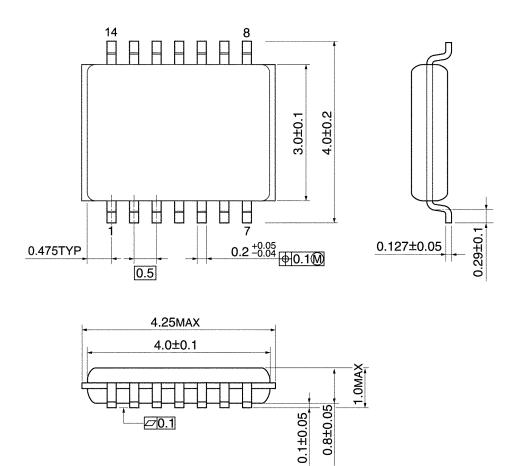
Characteristics	C: make al	Test Condition		Ta = 25°C		l loit
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V <sub>OL</sub>	VOLP	CL = 50 pF	3.3 5.0	0.3 0.7	_	V
Quiet output minimum dynamic VOL	VOLV	CL = 50 pF	3.3 5.0	-0.1 -0.2	_	V
Minimum high level dynamic input voltage	Vihd	CL = 50 pF	5.0		3.5	V
Maximum low level dynamic input voltage	VILD	CL = 50 pF	5.0		1.5	V



### **Package Dimensions**

VSSOP14-P-0030-0.50

Unit: mm



Weight: 0.02 g (typ.)

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